

Schottky Rectifier, 2 x 15 A



TO-220AB



FEATURES

- 150 °C T_J operation
- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)



PRODUCT SUMMARY	
Package	TO-220AB
I _{F(AV)}	2 x 15 A
V _R	35 V, 45 V
V _F at I _F	See Electrical table
I _{RM} max.	40 mA at 125 °C
T _J max.	150 °C
Diode variation	Common cathode
E _{AS}	16 mJ

DESCRIPTION

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS			
SYMBOL	CHARACTERISTICS	VALUES	UNITS
I _{F(AV)}	Rectangular waveform (per device)	30	A
V _{RRM}		35/45	V
I _{FRM}	T _C = 130 °C (per leg)	30	A
I _{FSM}	t _p = 5 μs sine	1060	
V _F	30 A _{pk} , T _J = 125 °C	0.73	V
T _J	Range	- 65 to 150	°C

VOLTAGE RATINGS						
PARAMETER	SYMBOL	VS-MBR2535CTPbF	VS-MBR2535CT-N3	VS-MBR2545CTPbF	VS-MBR2545CT-N3	UNITS
Maximum DC reverse voltage	V _R	35	35	45	45	V
Maximum working peak reverse voltage	V _{RWM}					

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	I _{F(AV)}	T _C = 130 °C, rated V _R	per leg	15	A
			per device	30	
Peak repetitive forward current per leg	I _{FRM}	Rated V _R , square wave, 20 kHz, T _C = 130 °C		30	
Non-repetitive peak surge current	I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated V _{RRM} applied	1060	
		Surge applied at rated load conditions halfwave, single phase, 60 Hz		150	
Non-repetitive avalanche energy per leg	E _{AS}	T _J = 25 °C, I _{AS} = 2 A, L = 8 mH		16	mJ
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to zero in 1 μs Frequency limited by T _J maximum V _A = 1.5 x V _R typical		2	A



ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop	$V_{FM}^{(1)}$	30 A	$T_J = 25\text{ }^\circ\text{C}$	0.82	V
			$T_J = 125\text{ }^\circ\text{C}$	0.73	
Maximum instantaneous reverse current	$I_{RM}^{(1)}$	Rated DC voltage	$T_J = 25\text{ }^\circ\text{C}$	0.2	mA
			$T_J = 125\text{ }^\circ\text{C}$	40	
Threshold voltage	$V_{F(TO)}$	$T_J = T_J \text{ maximum}$		0.355	V
Forward slope resistance	r_t			12.3	m Ω
Maximum junction capacitance	C_T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz) 25 $^\circ\text{C}$		700	pF
Typical series inductance	L_S	Measured from top of terminal to mounting plane		8.0	nH
Maximum voltage rate of change	dV/dt	Rated V_R		10 000	V/ μs

Note

(1) Pulse width < 300 μs , duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS		
Maximum junction temperature range	T_J			- 65 to 150	$^\circ\text{C}$		
Maximum storage temperature range	T_{Stg}			- 65 to 175			
Maximum thermal resistance, junction to case per leg	R_{thJC}	DC operation		1.5	$^\circ\text{C/W}$		
Typical thermal resistance, case to heatsink	R_{thCS}	Mounting surface, smooth and greased		0.50			
Approximate weight				2	g		
				0.07	oz.		
Mounting torque	<table border="0"> <tr> <td style="text-align: center;">minimum</td> </tr> <tr> <td style="text-align: center;">maximum</td> </tr> </table>	minimum	maximum	Non-lubricated threads		6 (5)	kgf · cm (lbf · in)
		minimum					
maximum							
12 (10)							
Marking device		Case style TO-220AB		MBR2535CT			
				MBR2545CT			

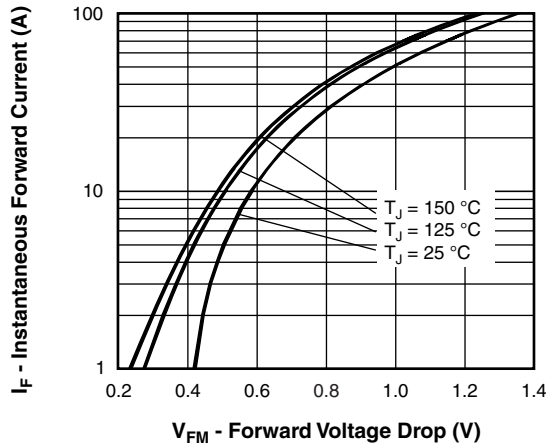


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

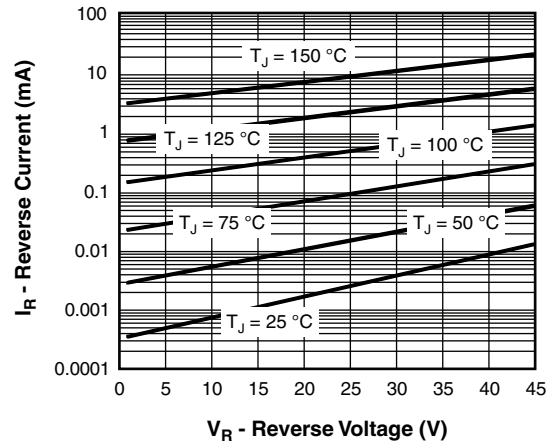


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

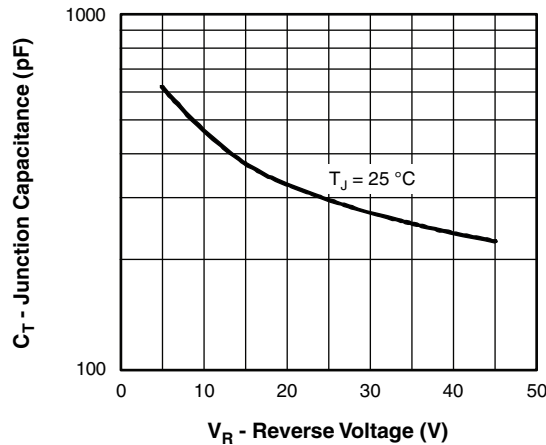


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

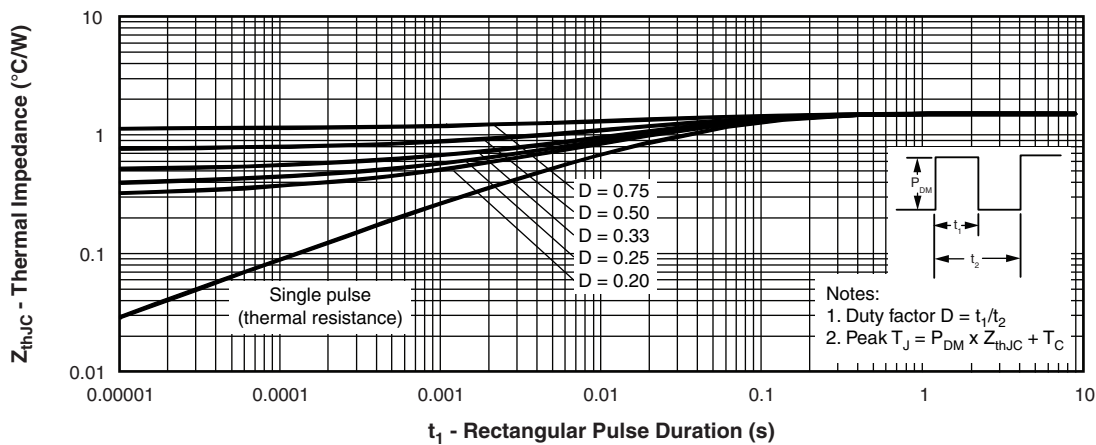


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

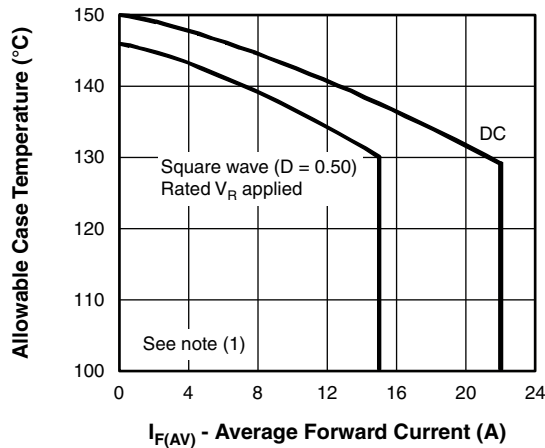


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

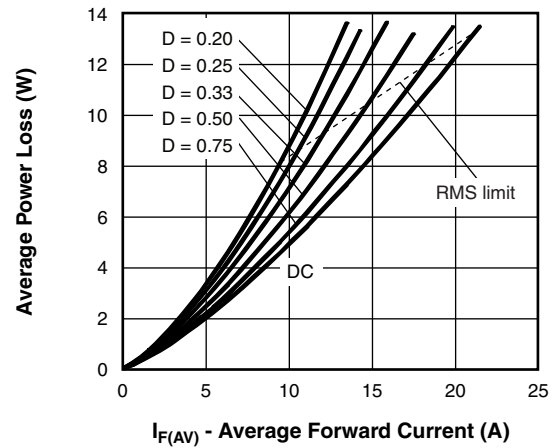


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

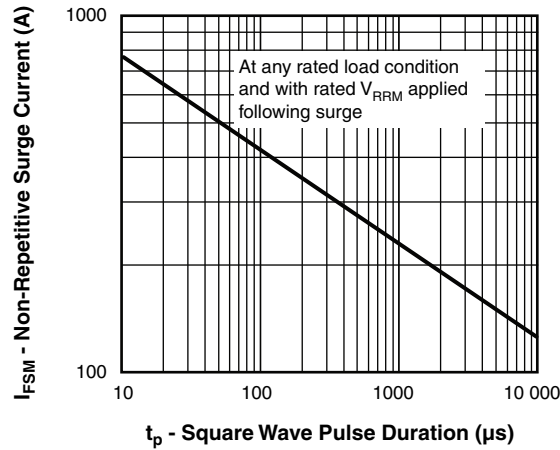


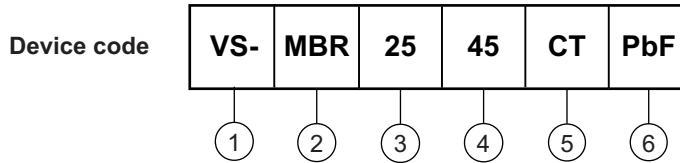
Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

- (1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;
- Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
- Pd_{REV} = Inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = Rated V_R



ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Schottky MBR series
- 3** - Current rating (30 A)
- 4** - Voltage ratings 35 = 35 V
45 = 45 V
- 5** - CT = Essential part number
- 6** - Environmental digit
 - PbF = Lead (Pb)-free and RoHS compliant
 - -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-MBR2535CTPbF	50	1000	Antistatic plastic tube
VS-MBR2535CT-N3	50	1000	Antistatic plastic tube
VS-MBR2545CTPbF	50	1000	Antistatic plastic tube
VS-MBR2545CT-N3	50	1000	Antistatic plastic tube

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95222
Part marking information	TO-220AB PbF www.vishay.com/doc?95225
	TO-220AB -N3 www.vishay.com/doc?95028

TO-220AB

DIMENSIONS in millimeters and inches



Lead assignments

Diodes

- 1. - Anode/open
- 2. - Cathode
- 3. - Anode

Conforms to JEDEC outline TO-220AB

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
c	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6
E	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
e	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
ϕP	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	
θ	90° to 93°		90° to 93°		

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline



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